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Trends in negative thermal expansion behavior for AMO_2 (A = Cu or Ag; M = Al, Sc, In, or La) compounds with the delafossite structure

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Abstract

Powder neutron diffraction data were obtained from 30 to 600 K for CuAlO₂, CuInO₂, CuLaO₂, 2H CuScO₂, 3R CuScO₂, and AgInO₂. Rietveld refinements of these data showed negative thermal expansion (NTE) of the O–Cu–O linkage in all cases. This behavior was especially strong for CuLaO₂ and CuScO₂, where it persisted up to our maximum measuring temperature of 600 K. This NTE in turn caused NTE of the *c* cell edge, which was moderated by the positive thermal expansion of the *M*–O bonds. The NTE behavior increases in the Cu*M*O₂ series as the size of *M* increases. No NTE behavior was found for the O–Ag–O linkage in AgInO₂; nonetheless, this compound did exhibit NTE for the *c* cell edge at low temperatures. For CuLaO₂ there is NTE for both the *a* and *c* cell edges at low temperatures. Structural trends for compounds with the delafossite structure are discussed with respect to both composition and temperature.

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1. Introduction

Strong negative thermal expansion (NTE) has now been established for many oxides with network structures having oxygen in two-fold coordination [1]. The NTE behavior in these cases is caused by the thermal motion of oxygen transverse to M–O–M linkages. The exceptionally large NTE behavior found for Zn(CN)₂ is presumably also related to transverse thermal motion of C and N in the Zn–C–N–Zn linkage [2]. There is apparently just one known example of NTE behavior in an oxide where the oxygen coordination is three. This is Zn₂SiO₄ where all oxygen atoms are three coordinated in an arrangement very close to planar [3]. This NTE behavior is presumably caused by oxygen thermal motion perpendicular to the plane of the three cations to which oxygen is bonded. This mechanism for NTE would then be analogous to the situation in graphite. Carbon is three coordinated, and thermal motion perpendicular to the strong bonds in the sheets results in NTE behavior for the a and b cell edges. The distance between the sheets increases with increasing temperature, leading to strong positive thermal expansion along the c-axis.

The thermal expansion behavior of several compounds isostructural with Zn_2SiO_4 has been studied; some show low thermal expansion, but none show any NTE behavior [4]. NTE behavior is also known in PbTiO₃, where the behavior is driven by the polyhedra becoming more regular with increasing temperature [1]. NTE behavior has also been observed in nonoxide materials such as $Sm_{0.75}Y_{0.25}S$ [5] and YbGaGe [6].

NTE behavior can also occur in oxides where the cation is in two-fold coordination. This coordination is rare, and the only two cations that are known to support

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Fig. 1. A fragment of the 3R AMO_2 delafossite structure with the *c*-axis vertical where small atoms are A (A = Ag, Cu), medium atoms are M (M = La, In, Sc, Al), and large atoms are O. The 3R and 2H forms differ by stacking along the *c*-axis: ABC stacking for 3R and ABAB for 2H.

two-fold coordination and NTE behavior are Cu(I) and Ag(I). The same cubic structure is found for Cu_2O and Ag₂O, and both compounds exhibit NTE behavior [7]. Compounds with the AMO₂ formula having the delafossite structure (Fig. 1) have two-fold coordination for the A cation, which can be Cu(I) or Ag(I). We have previously shown that 2H CuScO₂ with the delafossite structure shows NTE behavior for the c cell edge below room temperature [8]. The purpose of this paper is to compare the thermal expansion in the delafossite structure as the M and A cations are varied. Besides our study of 2H CuScO₂, there is only one publication on structure variation with temperature of a compound with delafossite structure. This is for CuAlO₂, where the temperature range was 295–1200 K [9]. No NTE behavior was observed over that temperature range.

2. Experimental

2.1. Synthesis

Reagents used were Cu₂O (Cerac, 99%), La₂O₃ (Aldrich, 99.99%), Al₂O₃ (Aldrich, 99.8%), Sc₂O₃ (Stanford Materials, 99.99%), CuCl (Alfa Aesar, 99%), Li₂CO₃ (Sigma, 99.6%), MgO (Aldrich, 99%), In₂O₃ (Cerac, 99.99%), Na₂CO₃ (Aldrich, 99.99%), AgNO₃ (Spectrum, 99.0%) and KOH (Mallinckrodt, AR). Samples of CuCl obtained from several manufacturers were all badly contaminated with Cu(II) oxyhydroxide. This impurity was removed by washing with dilute hydrochloric acid.

The CuLaO₂ sample was synthesized by the solidstate reaction of Cu₂O and La₂O₃ following the method of Cava et al. [10]. Freshly calcined La₂O₃ (1000 °C, air, overnight) was mixed with Cu₂O in a stoichiometric ratio, ground in an agate mortar, and pressed into pellets. These pellets were buried in powders of the same composition in an alumina crucible, covered, and heated in an argon flow at 1000 °C for 24 h.

The CuAlO₂ sample was prepared by a solid-state reaction in air. Equimolar amounts of Cu₂O and Al₂O₃ were mixed by grinding in an agate mortar and pressed into pellets. These pellets were heated at 1100 °C for 24 h and quench cooled in air.

Our synthesis methods for 2H and 3R $CuScO_2$ samples have previously been reported [8,11]. To prepare the pure 2H sample free of the 3R form 5% Mg is substituted for Sc.

The CuInO₂ sample was prepared by an ion-exchange reaction similar to that of 3R CuScO₂ [11]. Equimolar amounts of Na₂CO₃ and In₂O₃ were mixed and heated at 1000 °C in air for 12 h. The NaInO₂ powder obtained was mixed with purified CuCl in a molar ratio of 1:1.3, and the mixture was placed in a Cu crucible inside a stainless steel vessel with Ar flowing through. The vessel was then heated to 550 °C for 6 h. The reaction product was washed with 2 M aqueous NH₄OH to remove NaCl and excess CuCl. The final product was dried in air.

The polycrystalline sample of $AgInO_2$ was synthesized by a hydrothermal reaction. Stoichiometric amounts of $AgNO_3$ and In_2O_3 in 5 M KOH aqueous solution were sealed in a PTFE autoclave within a Parr bomb. The reaction was carried out at 250 °C for 7 days. The resulting orange highly crystalline $AgInO_2$ was washed with distilled water to remove the adsorbed KOH/ KNO₃ solution.

2.2. Neutron diffraction

Neutron powder diffraction data were collected using the BT-1 32-counter high-resolution diffractometer at the NIST Center for Neutron Research at the National Institute of Standards and Technology. A Cu(311) monochromator with a 90° take-off angle giving a wavelength of 1.5402(2) Å and in-pile collimation of 15 min of arc were used. The beam was masked to 1.1×5.1 cm at the sample. Data were collected over a 2θ range of 3–168° with a step size of 0.05° and a temperature range of 30-600 K. Our data for 2H CuScO₂ from 11 to 1206 K have been previously reported [8], but are given here again up to 600 K for comparison. In addition, data on 2H CuScO₂ was collected at 3.6 K using a Ge(733) monochromator with a takeoff angle of 120° giving a wavelength of 1.1976(2) Å. Additional data were also collected for CuLaO₂ at very low temperatures down to 4 K. Samples of 2H and 3R CuScO₂ and AgInO₂ were sealed in

vanadium containers 15.6 mm in diameter and 50 mm high, and samples of CuLaO₂, CuAlO₂ and CuInO₂ were sealed in vanadium containers 10.8 mm in diameter and 50 mm high. The measurement time for each temperature was 2-3 h. A vacuum furnace was used for measurements above room temperature, and a closed-cycle He refrigerator was used for measurements below room temperature. The data of CuScO₂, CuInO₂ and AgInO₂ were corrected for absorption [12]. All the data were fit by the Rietveld method using GSAS software [13,14].

3. Results

Compounds investigated in this study are CuAlO₂, CuInO₂, AgInO₂, CuLaO₂, and CuScO₂. All compounds have the 3R form of the delafossite structure, except that in the case of CuScO₂ both the 2H and the 3R forms were studied. The 2H structure was refined in space group $P6_3/mmc$ with atom positions of Cu $(\frac{1}{3}, \frac{2}{3}, \frac{1}{4}), M(0,0,0), \text{ and } O(\frac{1}{3}, \frac{2}{3}, z).$ The 3R structure was refined in space group $R\bar{3}m$ with hexagonal atom positions of Cu or Ag (0,0,0), $M(0,0,\frac{1}{2})$, and O (0,0,z). This study encompasses results from 49 different refinements. Due to space limitations, results are only presented here graphically. However, all agreement factors, atomic coordinates, thermal displacement factors, and interatomic distances are available in the CIF files. The absence of interstitial oxygen was confirmed by placing oxygen in the Cu triangles within the Cu planes. The occupancy of such sites always refined to values indistinguishable from zero.

Figs. 2 and 3 show the *a* and *c* cell edge variations with temperature. NTE behavior was observed at low temperature for all compounds investigated. Usually the NTE behavior was just for the *c* cell edge. The low temperature value of α was -1.0 to -1.8×10^{-6} /K in most cases but was only -0.4 and -0.5×10^{-6} /K for CuAlO₂ and CuInO₂, which makes the NTE effect difficult to see in Fig. 3. In the case of CuLaO₂ NTE behavior was found for both *a* and *c*. In no case was there NTE behavior for any cell edge above room temperature. In Fig. 4 the *c/a* ratio is plotted against temperature. This indicates that the thermal expansion is generally highly anisotropic, which is expected for such an anisotropic structure. However, nearly isotropic thermal expansion is found in the case of CuLaO₂.

The term atomic displacement factor has generally replaced the term thermal parameter because atomic displacements are not always thermally induced. We use the term thermal parameter here because the temperature dependences of these terms indicate they are basically true thermal parameters. Figs. 5–7 show the variations of thermal parameters with temperature. All atoms are on a three-fold axis. Thus, the thermal



Fig. 2. The *a* cell edges vs. temperature.

ellipsoids are either extended or flattened along this axis. U_{11} is perpendicular to the *c*-axis, and U_{33} is parallel to the *c*-axis. The most extreme anisotropic *U*s are for the *A* cation. As expected for two-fold linear coordination, the ellipsoids are flattened, and the U_{11}/U_{33} ratio can be four or higher. The opposite situation is generally found for the *M* cations. The ellipsoids are usually elongated along the *c*-axis. Anisotropic thermal motion would not be expected in a regular octahedron, but this octahedron is highly distorted. The more pronounced motion is in the direction of the two faces that are much larger than the other four faces. The main exception is found for

3.839



Fig. 3. The *c* cell edges vs. temperature. The values for 2H CuScO₂ have been multiplied by $\frac{3}{2}$ to allow direct comparison.

CuInO₂, where the distortion from a regular octahedron is not so great. Here thermal motion of oxygen is nearly isotropic, but there is a tendency of U_{11} to be somewhat higher than that of U_{33} . The standard uncertainties for U values vary from about the same size of the points (CuLaO₂) to about twice of the size of the points (CuInO₂) in Figs. 5-7. It is physically unreasonable for U_{11} or U_{33} to be negative, and these values were found to be positive for all atoms in all compounds at room temperature. However, some of these parameters did sometimes minimize to negative values at low temperatures, usually within a few standard uncertainties of zero. Applying corrections for absorption did not always rectify this. The lower range of these values is attributed to correlation between the U values and other fitted values, likely the background parameters. This



Fig. 5. Thermal displacement factors of A(I) cation (A = Cu, Ag) vs. temperature.



Fig. 6. Thermal displacement factors of M(III) (M = La, In, Sc, Al) vs. temperature.



Fig. 7. Thermal displacement factors of oxygen vs. temperature.

conclusion was supported by collecting data for 2H $CuScO_2$ at 3.6 K using a shorter neutron wavelength. This approximately doubles the number of accessible reflections, which increases the sensitivity of the fit to the thermal parameters. With this greater range of data, all U parameters refined to positive values or zero.

Fig. 8 plots our data for Cu U_{11} in CuAlO₂, together with the data from the previous single crystal X-ray study [9]. The agreement in the overlap area is very



Fig. 8. Comparison of thermal displacement factors of Cu U_{11} . Squares (this work, powder neutron diffraction) and triangles ([9], single crystal XRD) are for 3R CuAlO₂. Cross points are for 2H CuScO₂ ([8], powder neutron diffraction).

good. Our Cu U_{11} data for 2H CuScO₂ are also plotted for comparison, showing that Cu(I) maintains a larger thermal motion perpendicular to the *c*-axis in 2H CuScO₂ than in CuAlO₂ up to high temperatures.

The variations of the uncorrected and corrected A-O distances with temperature are shown in Fig. 9, indicating that strong NTE behavior persists in some cases up to our maximum measuring temperature of 600 K. The M-O distances vs. temperature are in Fig. 10, and the thicknesses of the $(MO_2)^{1-}$ layers as a function of temperature are shown in Fig. 11. Due to the high symmetry of this structure, the A-A distance, the M-M distance, and one O-O distance are the same as a cell edge.

The values of the cell edges can be determined with greater accuracy than the bond distances. Thus, the estimated errors for *a*, *c*, and *T* are less than the size of the points in the figures. The estimated errors for the values in Figs. 9–11 depend on the accuracy of the determination of the O(z) parameter. Estimated uncertainties for interatomic distances vary with the intensities of the various diffraction patterns giving the following estimates for the strongest pattern (CuLaO₂) and the weakest pattern (CuInO₂), respectively: 0.0001–0.0003 Å for *M*–O, 0.0003–0.0007 Å for *A*–O, and 0.0006–0.0015 Å for the sheet thickness.

4. Discussion

4.1. Trends with composition

Before discussion of trends with temperature, it is important to discuss some trends in the delafossite structure with variations of the A and M cations. It has been previously noted by Jansen that the Cu–O distance in Cu MO_2 delafossites decreases as the size of M and



Fig. 9. The temperature dependence of *A*–O bond distances. Open symbols are uncorrected bond distances. Solid symbols are corresponding bond distances corrected by riding model.

consequently the Cu-Cu distance increases [15]. We also note the same trend for the Ag–O distances in $AgMO_2$ delafossites (Fig. 12). Jansen had rationalized this behavior for CuMO₂ delafossites on the basis of competition between Cu-O bonding and Cu-Cu bonding. Thus, as one bond becomes shorter and stronger, the other bond becomes longer and weaker. One would not normally expect any bonding interaction between $nd^{10}(n+1)s^0$ cations such as Cu(I) and Ag(I). However, strong d-s hybridization occurs on Cu and Ag due to the linear O-A-O linkages. This effectively transfers some electron density from the filled d shell to the empty s shell. The A-A interaction then becomes weakly bonding, creating an attractive force that is balanced by repulsion between the cores. It is this A-A bonding interaction that presumably provides the conduction



Fig. 10. The M-O bond distances vs. temperature.

mechanism for p-doped Cu MO_2 compounds with the delafossite structure. However, the A-A bond appears too weak to explain the trend in Fig. 12. We have suggested an alternate explanation [28]. The $s-d_z 2$ hybridization of the A cations necessary to form the two-fold linear bonds to oxygen effectively polarizes the filled shell leading to an increase of the A-A repulsion. As the A cations are forced closer by the smaller M cations, this polarization is forced to decrease, forcing increased antibonding electron density for the A-O bond. Thus, the A-O bond becomes weaker and longer. This explanation was subsequently supported by calculations [27].

Because all the O–A–O linkages are strictly parallel to the *c*-axis, one expects that the value of the *a* cell edge will scale only with the size of the *M* cation. Thus, the magnitudes of the *a* cell edges for Ag MO_2 and Cu MO_2 compounds with the same *M* cation are nearly the same (Fig. 13). The small differences that do exist in the *a* cell edges for compounds with the same *M* cation can give important clues as to the nature of the *A*–*A* interaction. For small values of the *a* cell edge, the Ag MO_2



Fig. 11. Thicknesses of the $(MO_2)^{1-}$ layers as a function of temperature.

compound has a larger *a* cell edge than does the Cu MO_2 compound. This can be rationalized on the basis that Ag is larger than Cu, and Ag–Ag repulsive forces will dominate at the smaller A-A distances. The opposite trend occurs at larger A-A distances: the Cu MO_2 compounds have a larger *a* cell edge than do the corresponding Ag MO_2 compounds. This crossover has been predicted from calculations [27]. Such a crossover indicates potential energy curves as shown in Fig. 14. It is assumed that the A-A interaction becomes attractive at large A-A distances, but a crossover could also be consistent with the A-A interaction being repulsive at all distances.

The length of the c cell edge is influenced by both the A-O distance and the M-O distance. If the Cu-O and Ag-O distances remained constant, one would expect a significant increase in the c cell edge as the size of M increases. However as noted above, the A-O distances actually decrease as the size of M increases (Fig. 12). Thus, changes of the A-O and M-O distances as M is



Fig. 12. Variation of A-O bond distances with the size of M cations. Solid circles, from left to right, are for AgAlO₂ [16], AgCoO₂ [17], AgNiO₂ [17], AgCrO₂ [18], AgFeO₂ [19,20], and AgInO₂ [21]. Open circles, from left to right, are for CuAlO₂ [9], CuCrO₂ [22], CuGaO₂ [23], CuFeO₂ [19,20], CuScO₂ [24], CuInO₂ [25], CuYO₂ [23], and CuLaO₂ [26]. Triangles are data points from this work. Cross points are calculated data (GGA) by Kandpal et al. [27].

varied tend to compensate. The slightly larger increase in the size of the *c* cell edge with increasing *M* size for Ag MO_2 compounds (Fig. 15) relative to Cu MO_2 compounds is related to the crossover of the *a* cell edge of Cu MO_2 and Ag MO_2 compounds (Fig. 13). The *a* cell edge does not increase as rapidly with *M* size for Ag MO_2 compounds as it does for Cu MO_2 compounds. Thus, this increase in the size of *M* has a more pronounced impact on the *c* cell edge for the Ag MO_2 compounds.

One must also consider the impact of cation–cation repulsion across the edge-shared octahedra of the $(MO_2)^{1-}$ sheets. This repulsion will increase with the real charge on the M(III) cations and will thus increase as the M(III) cations become more electropositive. The lowest repulsion among M(III) cations we have studied is expected for In, because In has the highest electronegativity. Thus, for CuInO₂ and AgInO₂ the $(MO_2)^{1-}$ sheets are less stretched and are therefore thicker (Fig. 11), causing a larger c cell edge than would be otherwise expected (Figs. 3 and 15).

The differences between $CuInO_2$ and $AgInO_2$ are also interesting. The Ag–O bond being weaker than the Cu–O bond causes the In–O bond to be stronger and shorter in AgInO₂ than in CuInO₂ (Fig. 10). This in turn results in the *a* cell edge for AgInO₂ being smaller than for CuInO₂ (Fig. 2).

A curious feature of the delafossite structure is that the M-O-M angle is constrained by space group



Fig. 13. Variation of cell edge *a* with the size of *M* cations. Solid circles, from left to right, are for AgAlO₂ [16], AgCoO₂ [17], AgNiO₂ [17], AgCrO₂ [18], AgGaO₂ [24], AgFeO₂ [19,20], AgRhO₂ [19], AgScO₂ [28] and AgInO₂ [21]. Open circles, from left to right, are for CuAlO₂ [9], CuCoO₂ [19], CuCrO₂ [22], CuGaO₂ [23], CuFeO₂ [19,20], CuRhO₂ [19], CuScO₂ [24], and CuInO₂ [25]. The diamond is for AgInO₂ (this work), and cross points are for CuMO₂ (this work). Triangles are calculated (GGA) data for AgMO₂ and squares are calculated (GGA) data for CuMO₂ [27].



Fig. 14. Schematic of potential energy vs. A - A distance (A = Ag, Cu).

symmetry to be exactly the same as one of the two O–M–O angles. (The sum of the two O–M–O angles is 180°). This angle is plotted vs. the size of M(III) in Fig. 16. Oxygen is tetrahedrally coordinated (A + 3M), and M is octahedrally coordinated. It is impossible for the M–O–M and O–M–O angles plotted in Fig. 16 to have the ideal values of 109° and 90°. Thus, this angle is



Fig. 15. Variation of cell edge c with the size of M cations. Solid circles, from left to right, are for AgAlO₂ [16], AgCoO₂ [17], AgNiO₂ [17], AgCrO₂ [18], AgGaO₂ [24], AgFeO₂ [19,20], AgRhO₂ [19], AgScO₂ [28] and AgInO₂ [21]. Open circles, from left to right, are for CuAlO₂ [9], CuCoO₂ [19], CuCrO₂ [22], CuGaO₂ [23], CuFeO₂ [19,20], CuRhO₂ [19], CuScO₂ [24], CuInO₂ [25], CuYO₂ [23], CuEuO₂ [26], CuSmO₂ [26], CuNdO₂ [29], CuPrO₂ [26], CuLaO₂ [26]. The diamond is for AgInO₂ (this work), and cross points are for Cu MO_2 (this work). Triangles are calculated (GGA) data for Ag MO_2 and squares are calculated (GGA) data for Cu MO_2 [27].



Fig. 16. Bond angles M-O-M (or O-M-O) vs. the size of M cations. Cross points, from left to right, are for AgAlO₂ [16], AgCoO₂ [17], AgNiO₂ [17], AgCrO₂ [18], AgFeO₂ [19,20] and AgInO₂ [21]. Open circles, from left to right, are for CuAlO₂ [9], CuCrO₂ [22], CuGaO₂ [23], CuFeO₂ [19,20], CuScO₂ [24], CuInO₂ [25], CuYO₂ [23], CuLaO₂ [26]. The square is for AgInO₂ (this work), and the triangles are for Cu MO_2 (this work).

always intermediate between these two ideal values and tends to increase with increasing size of M (Fig. 16).

4.2. Trends with temperature

NTE behavior of the c cell edge is observed in all six compounds we examined (Fig. 3). The NTE behavior for c exists only below room temperature because with increasing temperature it is overwhelmed by the positive thermal expansion of the M-O bonds (Fig. 10). For $CuMO_2$ compounds, the NTE behavior of c can always be attributed to the apparent NTE behavior of the Cu-O bond distance (Fig. 9). This behavior can in turn be related to the large thermal displacements of Cu perpendicular to the O-Cu-O linkage. Correction for this thermal motion generally gives Cu-O distances that increase with increasing temperature (Fig. 9). The correction used was a riding motion correction [30], which assumes that the thermal motion of the A cation is in the same direction as the thermal motion of oxygen. If this correlation were not assumed, the corrected A–O distances would increase even more with increasing temperature. We had previously suggested that the degree of NTE behavior was linked to the Cu-Cu distance [8]. As this distance becomes smaller, the transverse thermal motion of the A cation would be impeded. In fact, the smallest U_{11} values for Cu are found in CuAlO₂ where the Cu-Cu distance is the smallest (Fig. 5). Furthermore, the strongest low temperature NTE behavior for the apparent Cu-O distance is found in CuLaO₂ ($\alpha = -6.4 \times 10^{-6}/\text{K}$) compared to $\alpha = -5.9 \times 10^{-6}/K$ in 3R CuScO₂ and $\alpha = -3.2 \times 10^{-6}$ /K in CuAlO₂. Also, the NTE behavior for the apparent Cu-O distance has disappeared by 500 K for CuAlO₂ whereas it continues strong to higher temperatures in CuLaO₂. The NTE behavior of the corrected Cu–O distance at low temperature in CuLaO₂ suggests that the riding motion correction is too conservative.

There is no indication of NTE behavior for the Ag-O distance in $AgInO_2$ (Fig. 9). This might be considered surprising in view of the stronger NTE behavior of Ag_2O compared to that of Cu_2O [7]. However, the Ag–Ag distance in Ag₂O is 3.42 Å whereas this distance is only 3.28 Å in AgInO₂. Thus, the Ag thermal displacements perpendicular to O-Ag-O linkages will be inhibited in AgInO₂ relative to Ag₂O. In fact, the magnitude of the thermal motion of Ag perpendicular to the O-Ag-O linkage in Ag₂O is reported to be more than two times what we find in $AgInO_2$ [31,32]. Thus, although the U_{11} values for Ag in AgInO₂ are comparable to those of CuMO₂ compounds showing NTE behavior, this is not enough to compensate for the very large intrinsic thermal expansion of the Ag-O bond. Weaker bonds show higher thermal expansion than stronger bonds, and an Ag-O bond is weaker than a Cu-O bond. Thus, the high temperature thermal expansion in AgInO₂ for both the Ag-O distance and the c cell edge is much higher than the corresponding values for the $CuMO_2$ delafossites (Figs. 3 and 9).

For AMO_2 delafossites it is the decrease in the M-O distance with decreasing temperature that primarily causes the *a* cell edge to decrease with decreasing temperature. However, the forces between the *A* cations can also be expected to have some impact on the thermal expansion of the *a* cell edge, and Ag-Ag and Cu-Cu

repulsive or attractive forces are not the same (Fig. 14). The A-A distances for these AInO₂ compounds lie to the right of the minima in Fig. 14. Thus, the Ag-Ag attractive forces in AgInO₂ are expected to be stronger than the Cu-Cu attractive forces in CuInO₂. On cooling, this could in turn cause a stronger contraction of the *a* cell edge in AgInO₂ than in CuInO₂, as observed. This greater thermal contraction with decreasing temperature of the *a* cell edge for AgInO₂ causes the slight expansion of the (InO₂)¹⁻ layer at lower temperatures and consequently a small NTE effect for the *c*-axis.

Comparisons of trends for 2H and 3R CuScO₂ are complicated by the fact that Mg substitution for Sc was used to stabilize the 2H form. We know that it is this substitution that causes the smaller *a* cell edge and the larger *c* cell edge for our 2H sample [11]. The effect of the smaller Mg(II) for Sc(III) is also clearly seen in the plot of *M*–O distances vs. temperature in Fig. 10. The larger Cu–O distance and resultant longer *c* cell edge for 2H CuScO₂ are again more likely due to the Mg substitution than the different stacking along the *c*-axis.

The most surprising NTE behavior found in this study is that of the *a* cell edge for $CuLaO_2$ at low temperatures (Fig. 2). Data were collected at more temperatures in the low temperature range for CuLaO₂ to confirm with certainty the cause of this behavior. This NTE behavior is not caused by NTE behavior of the La-O distance (Fig. 10). Rather it is caused by continued shrinkage of the thickness of the $(LaO_2)^{1-}$ sheet with decreasing temperature (Fig. 11), even after the La–O distance has leveled off. The other $(MO_2)^{1-}$ sheets also show continued shrinkage down to low temperatures, but not as so strongly as for CuLaO₂. Furthermore, the La–O distance flattens out sooner with decreasing temperature than for the other compounds. Geometric considerations dictate that a decreasing $(LaO_2)^{1-}$ sheet thickness coupled with an invariant La-O distance will directly cause an increase in the a cell edge.

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